

Features

- Split Gate Trench MOSFET Technology
- Low $R_{DS(on)}$ & FOM
- Low C_{rss}
- Extremely Low Switching Loss
- Excellent Stability and Uniformity
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)
- Moisture Sensitivity Level 1

Maximum Ratings

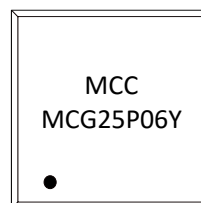
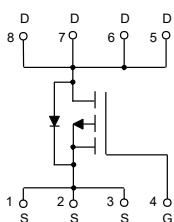
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance:50°C/W Junction to Ambient(Steady-State)⁽²⁾
- Thermal Resistance:1.7°C/W Junction to Case(Steady-State)

| Parameter | Symbol | Rating | Unit |
|---|----------|-------------------------|-------|
| Drain-Source Voltage | V_{DS} | -60 | V |
| Gate-Source Voltage | V_{GS} | ±20 | V |
| Continuous Drain Current | I_D | $T_C=25^\circ\text{C}$ | -25 |
| | | $T_C=100^\circ\text{C}$ | -15.8 |
| Pulsed Drain Current ⁽³⁾ | I_{DM} | -75 | A |
| Total Power Dissipation ⁽⁴⁾ | P_D | 73.5 | W |
| Single Pulsed Avalanche Energy ⁽⁵⁾ | E_{AS} | 81 | mJ |

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The Power dissipation P_{DSM} is based on $R_{\theta JA} t \leq 10\text{s}$ and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-case thermal resistance.
5. $V_{DD}=-50\text{V}$, $R_G=25\Omega$, $L=0.5\text{mH}$, $I_{AS}=-18\text{A}$

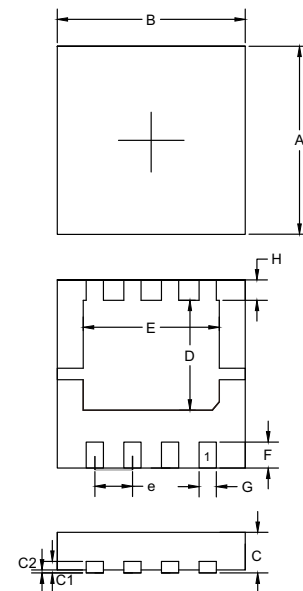
Internal Structure and Marking Code



pin1

P-CHANNEL MOSFET

DFN3333



| DIM | INCHES | | MM | | NOTE |
|-----|--------|-------|------|------|------|
| | MIN | MAX | MIN | MAX | |
| A | 0.126 | 0.130 | 3.20 | 3.30 | |
| B | 0.126 | 0.130 | 3.20 | 3.30 | |
| C | 0.030 | 0.033 | 0.75 | 0.85 | |
| C1 | 0.007 | 0.009 | 0.18 | 0.22 | |
| C2 | --- | 0.002 | --- | 0.05 | |
| D | 0.071 | 0.079 | 1.80 | 2.00 | |
| E | 0.087 | 0.098 | 2.20 | 2.50 | |
| F | 0.016 | 0.020 | 0.40 | 0.50 | |
| G | 0.010 | 0.014 | 0.25 | 0.35 | |
| H | 0.012 | 0.016 | 0.30 | 0.40 | |
| e | 0.024 | 0.028 | 0.60 | 0.70 | |

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------|---------------|---|------|-------|-----------|------------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=-250\mu A$ | -60 | | | V |
| Gate-Source Leakage Current | I_{GSS} | $V_{DS}=0V, V_{GS}=\pm 20V$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=-60V, V_{GS}=0V$ | | | -1 | μA |
| Gate-Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=-250\mu A$ | -1.5 | -2.1 | -2.7 | V |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS}=-10V, I_D=-20A$ | | 38 | 50 | m Ω |
| | | $V_{GS}=-4.5V, I_D=-10A$ | | 48 | 65 | |
| Gate Resistance | R_g | F=1 MHz, Open drain | | 12 | | Ω |
| Diode Characteristics | | | | | | |
| Continuous Body Diode Current | I_S | | | | -25 | A |
| Diode Forward Voltage | V_{SD} | $V_{GS}=0V, I_S=-20A$ | | -0.95 | -1.3 | V |
| Reverse Recovery Time | t_{rr} | $I_F=-20A, dI_F/dt=100A/\mu s$ | | 28.3 | | ns |
| Reverse Recovery Charge | Q_{rr} | | | 20.2 | | nC |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=-30V, V_{GS}=0V, f=1MHz$ | | 1024 | | pF |
| Output Capacitance | C_{oss} | | | 386 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 22 | | |
| Total Gate Charge | Q_g | $V_{DS}=-30V, V_{GS}=-10V, I_D=-20A$ | | 17.4 | | nC |
| Gate-Source Charge | Q_{gs} | | | 3.83 | | |
| Gate-Drain Charge | Q_{gd} | | | 2.94 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}=-30V, V_{GS}=-10V, R_{GEN}=6\Omega$ | | 7.9 | | ns |
| Turn-On Rise Time | t_r | | | 4.63 | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 42.4 | | |
| Turn-Off Fall Time | t_f | | | 15.7 | | |

Curve Characteristics

Fig. 1 - Typical Output Characteristics

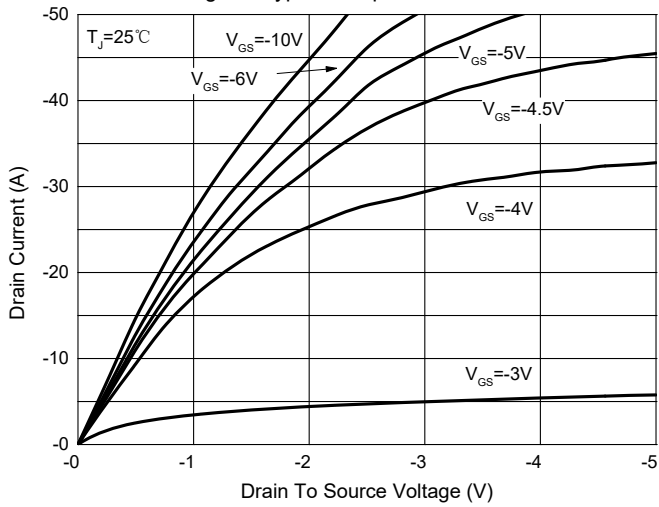


Fig. 2 - Transfer Characteristics

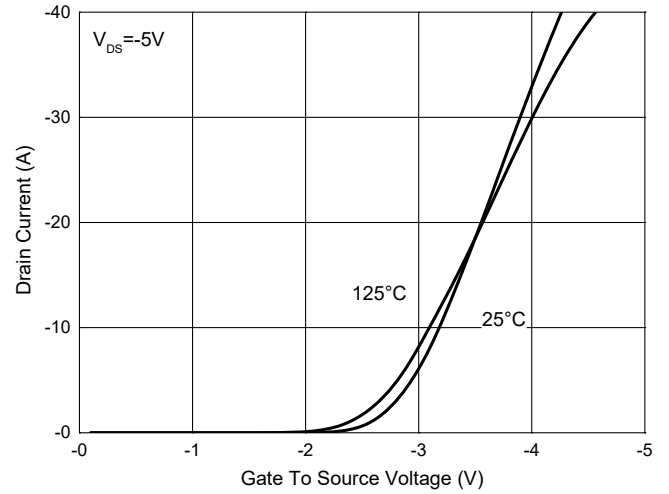


Fig. 3 - $R_{DS(ON)} - I_D$

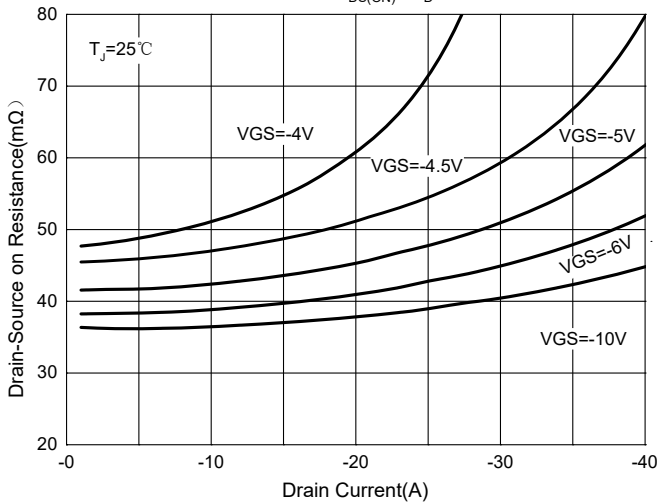


Fig.4-NormalizedOnResistanceCharacteristics

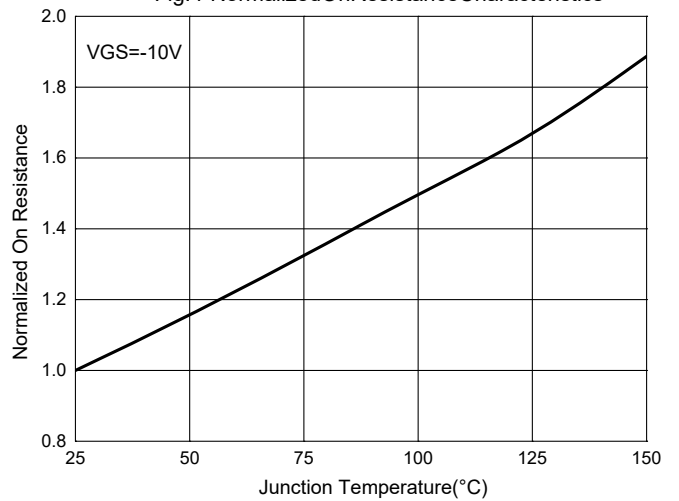


Fig. 5 - Capacitance Characteristics

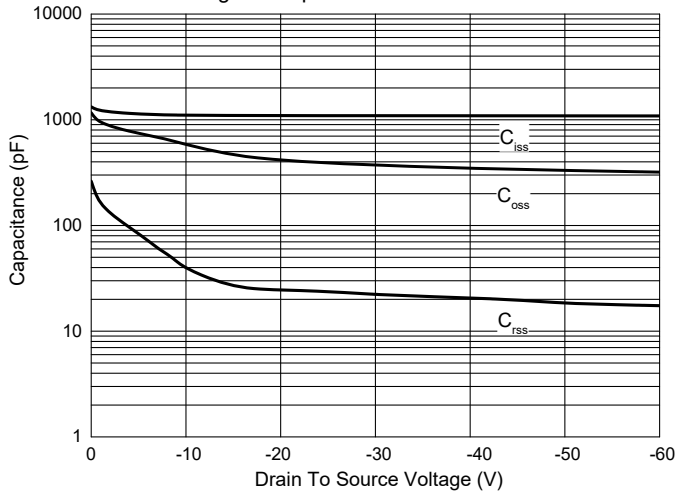
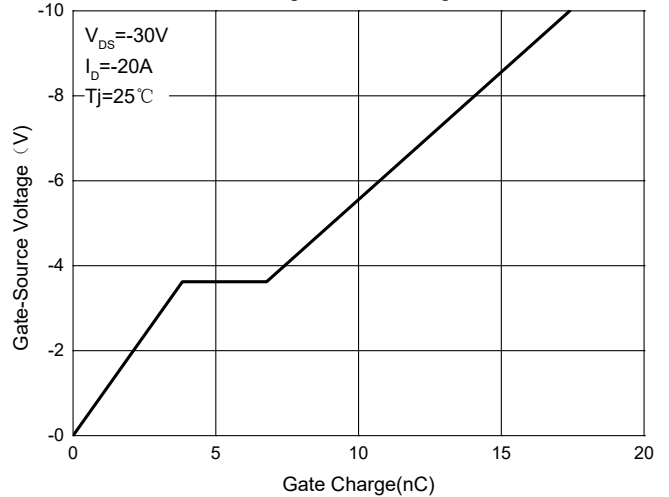


Fig. 6 - GateCharge



Curve Characteristics

Fig. 7 - $R_{DS(ON)} - V_{GS}$

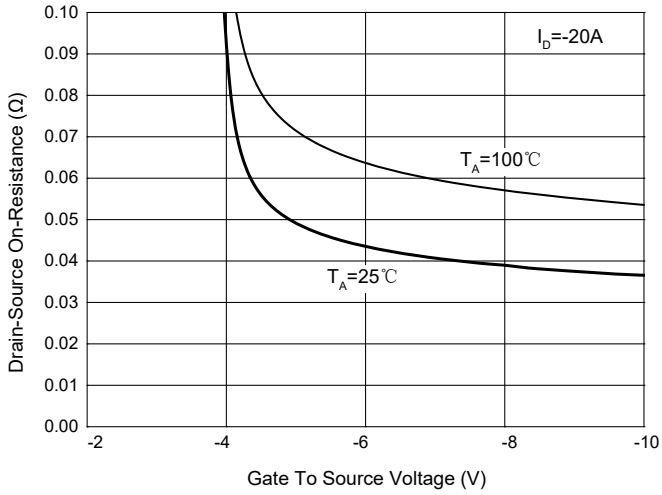


Fig. 8 - $V_{TH} - T_J$

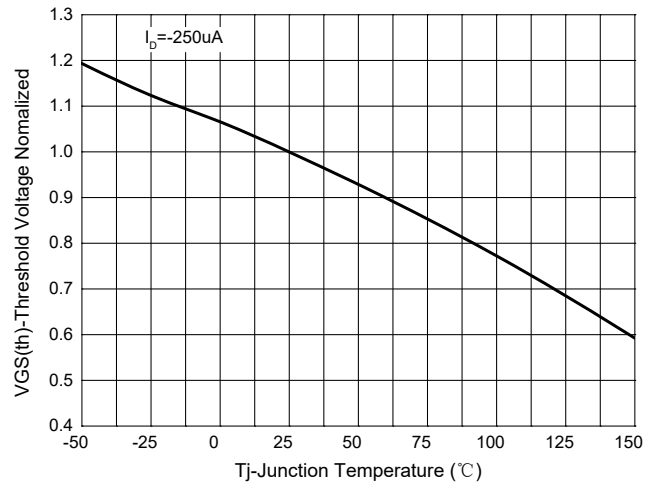


Fig. 9 - $I_S - V_{SD}$

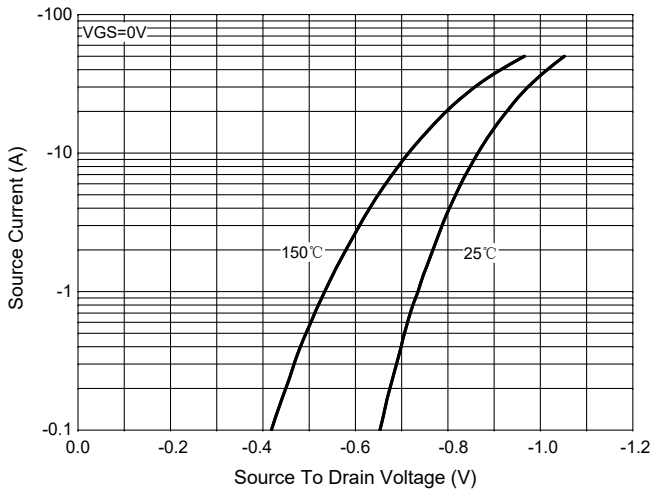


Fig. 10 - Current dissipation

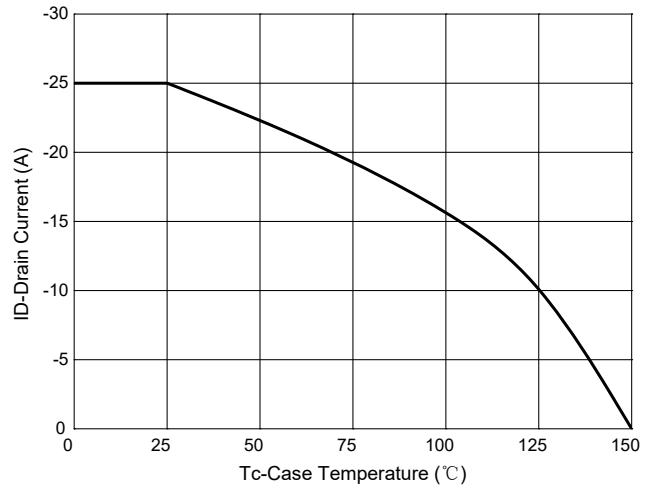
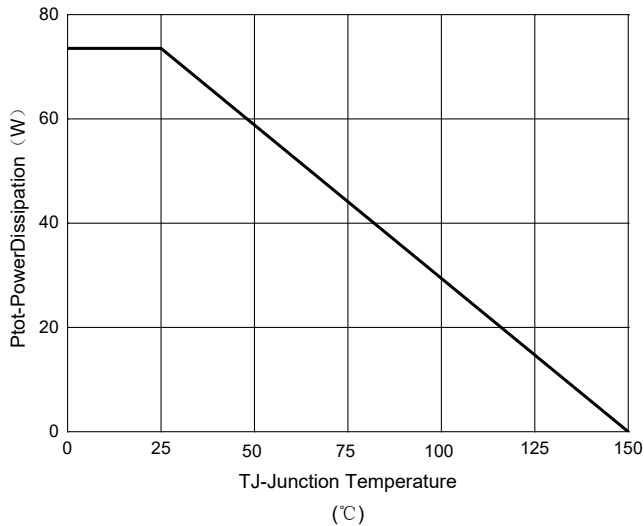


Fig. 11 - Power Dissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

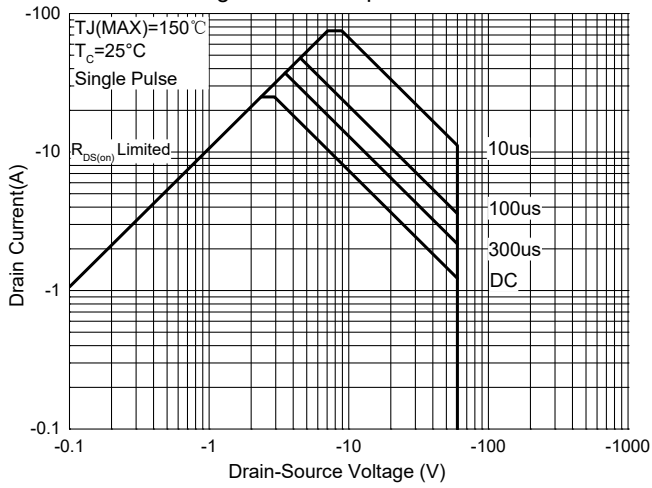
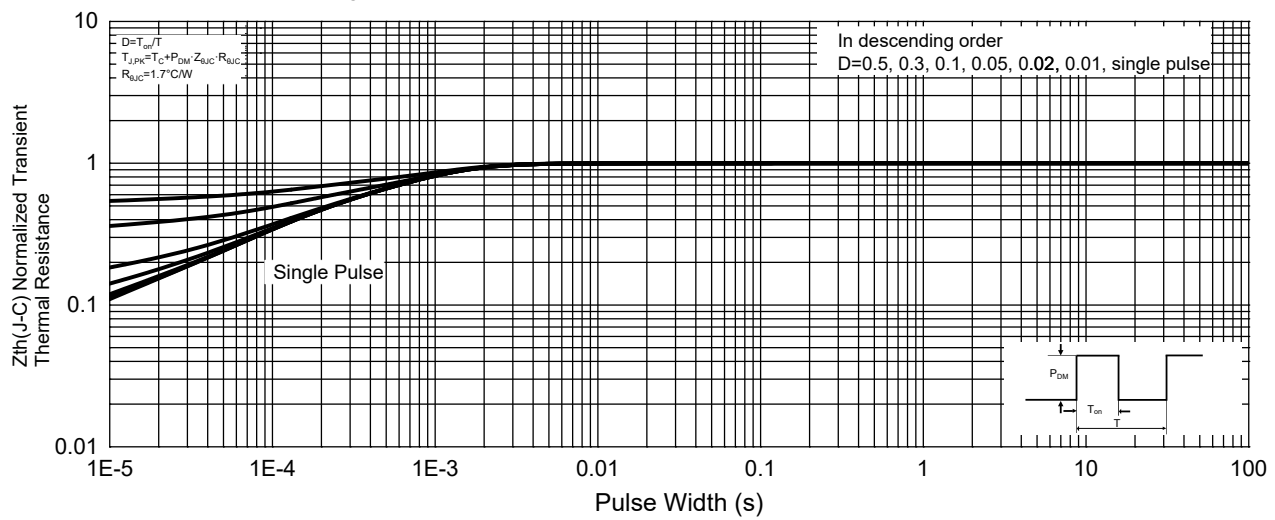


Fig. 13 -Normalized Transient Thermal Impedance



Ordering Information

| Device | Packing |
|--------------|-----------------------|
| MCG25P06Y-TP | Tape&Reel: 5Kpcs/Reel |

*****IMPORTANT NOTICE*****

Micro Commercial Components Corp. reserves the right to make changes without further notice to any product herein to make corrections, modifications, enhancements, improvements, or other changes. *Micro Commercial Components Corp.* does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold *Micro Commercial Components Corp.* and all the companies whose products are represented on our website, harmless against all damages. *Micro Commercial Components Corp.* products are sold subject to the general terms and conditions of commercial sale, as published at <https://www.mccsemi.com/Home/TermsAndConditions>.

*****LIFE SUPPORT*****

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

*****CUSTOMER AWARENESS*****

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. **MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources.** MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.